

## 2SB1387

## **Absolute Maximum Ratings** (Ta = $25^{\circ}$ C)

Item	Symbol	Ratings	Unit	
Collector to base voltage	V <sub>CBO</sub>	-120	V	
Collector to emitter voltage	V <sub>CEO</sub>	-120	V	
Emitter to base voltage	V <sub>EBO</sub>	-7	V	
Collector current	I <sub>c</sub>	-1.5	A	
Collector peak current	İ <sub>C(peak)</sub>	-3.0	А	
C to E diode forward current	I <sub>D</sub>	1.5	А	
Collector power dissipation	Pc	0.9	W	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

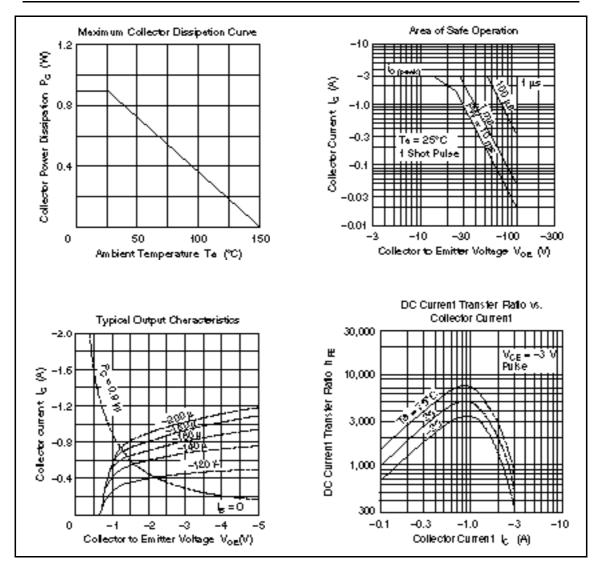
## **Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-120	_	—	V	$I_{c} = -0.1 \text{ mA}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	-120	_	—	V	$I_c = -10 \text{ mA}, R_{BE} =$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	-7	_	—	V	$I_{\rm E} = -50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>			-1	μA	$V_{\rm CB} = -100 \text{ V}, I_{\rm E} = 0$
	I <sub>CEO</sub>			-10	μA	$V_{ce} = -100 \text{ V}, \text{ R}_{be} =$
DC current transfer ratio	h <sub>FE</sub>	2000		10000		$V_{ce} = -3 \text{ V}, \text{ I}_{c} = -1 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{\text{CE}(\text{sat})1}$	_	_	-1.5	V	$I_c = -1 \text{ A}, I_B = -1 \text{ mA}^{*1}$
	$V_{\text{CE(sat)2}}$	_		-2.0	V	$I_{c} = -1.5 \text{ A}, I_{B} = -1.5 \text{ mA}^{*1}$
Base to emitter saturation voltage	$V_{\text{BE(sat)1}}$	_	_	-2.0	V	$I_{c} = -1 \text{ A}, I_{B} = -1 \text{ mA}^{*1}$
	$V_{BE(sat)^2}$			-2.5	V	$I_{c} = -1.5 \text{ A}, I_{B} = -1.5 \text{ mA}^{*1}$
C to E diode forward voltage	V <sub>D</sub>			3.0	V	I <sub>D</sub> = 1.5 A <sup>*1</sup>

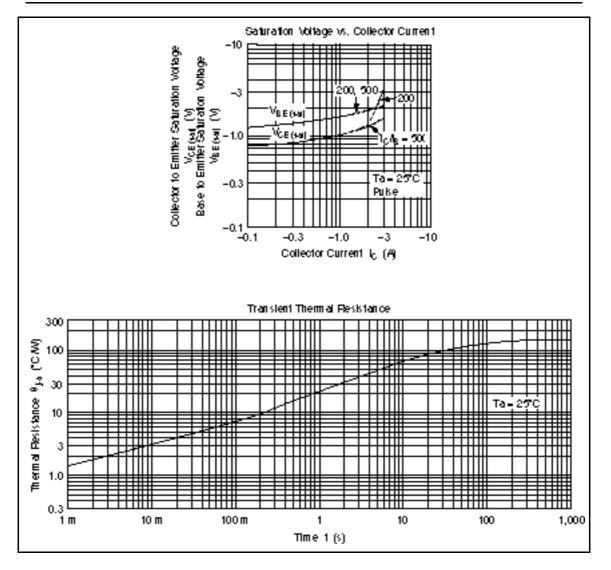
Note: 1. Pulse test

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